

Lonten N-channel 40V, 18A, 7.5mΩ Power MOSFET

Description

These N-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and with stand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

Features

- 40V, 18A, $R_{DS(ON).max} = 7.5 m\Omega@V_{GS} = 10V$
- Improved dv/dt capability
- Fast switching
- Green device available

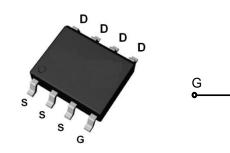
Applications

- Motor Drives
- ◆ UPS
- DC-DC Converter

Product Summary

 $\begin{array}{lll} V_{DSS} & 40V \\ R_{DS(on).max} @ \ V_{GS} \!\!=\!\! 10V & 7.5 m\Omega \\ I_D & 18A \end{array}$

SOP-8 Pin Configuration



N-Channel MOSFET



Absolute Maximum Ratings T_A = 25°C unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{ extsf{DSS}}$	40	V
Continuous drain current (T _A = 25°C)	,	18	А
Continuous drain current (T _A = 100°C)	I _D	11.5	А
Pulsed drain current ¹⁾	I _{DM}	72	А
Gate-Source voltage	V_{GSS}	±20	V
Power Dissipation (T _A = 25°C)	P _D	3.1	W
Storage Temperature Range	T _{STG}	-55 to +150	°C
Operating Junction Temperature Range	TJ	-55 to +150	°C

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	$R_{ heta JA}$	40	°C/W



Package Marking and Ordering Information

Device	Device Package	Marking
LNL04R075	SOP-8	LNL04R075

Electrical Characteristics T_J = 25°C unless otherwise noted

Parameter Parameter	Symbol	Test Condition	Min.	Тур.	Max.	Unit
Static characteristics	1				I	
Drain-source breakdown voltage	BV _{DSS}	V _{GS} =0 V, I _D =250uA	40			V
Gate threshold voltage	$V_{GS(th)}$	V _{DS} =V _{GS} , I _D =250uA	1.0	1.5	2.0	V
Drain-source leakage current		V _{DS} =40 V, V _{GS} =0 V, T _J = 25°C			1	μA
	I _{DSS}	V _{DS} =32 V, V _{GS} =0 V, T _J = 125°C			10	μA
Gate leakage current, Forward	I _{GSSF}	V _{GS} =20 V, V _{DS} =0V			100	nA
Gate leakage current, Reverse	I _{GSSR}	V _{GS} =-20 V, V _{DS} =0V			-100	nA
Drain source on state registeres	В	V _{GS} =10 V, I _D =10A		6.0	7.5	mΩ
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =4.5 V, I _D =8A		7.5	9.5	mΩ
Forward transconductance	g _{fs}	V _{DS} =5 V , I _D =10A		35		S
Dynamic characteristics						
Input capacitance	C _{iss}			2370		
Output capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V},$		316		pF
Reverse transfer capacitance	C _{rss}	F = 1MHz		212		
Turn-on delay time	t _{d(on)}			23.6		
Rise time	t _r	$V_{DD} = 20V, V_{GS} = 10V, I_{D} = 9A$		98.8		ne
Turn-off delay time	$t_{d(off)}$	V _{DD} = 20V, V _{GS} =10V, I _D =9A		220		- ns
Fall time	t _f			86.6		
Gate charge characteristics						
Gate to source charge	Q _{gs}	V 90V I 40A		9.3		
Gate to drain charge	Q_{gd}	V _{DS} =20V, I _D =10A,		6.8		nC
Gate charge total	Q_g	- V _{GS} = 10 V		34.2		
Drain-Source diode characteristi	cs and Maxi	mum Ratings				
Continuous Source Current	Is				18	Α
Pulsed Source Current	I _{SM}]			72	Α
Diode Forward Voltage ²⁾	V _{SD}	V _{GS} =0V, I _S =10A, T _J =25℃			1.2	V
Reverse Recovery Time	t _{rr}			24.2		ns
Reverse Recovery Charge	Q _{rr}	I _S =9A,di/dt=100A/us, T _J =25℃		12.3		nC

Notes:

- ${\bf 1: Repetitive \ Rating: Pulse \ width \ limited \ by \ maximum \ junction \ temperature.}$
- 2: Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.

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Electrical Characteristics Diagrams

Figure 1. Typ. Output Characteristics

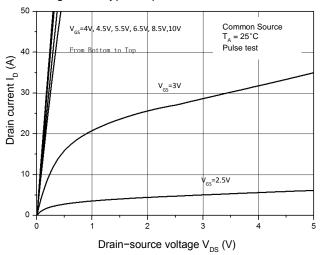


Figure 2. Transfer Characteristics

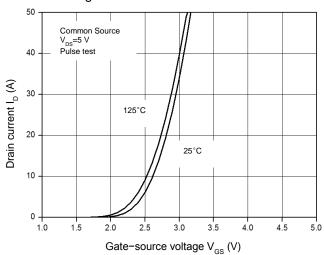


Figure 3. Capacitance Characteristics

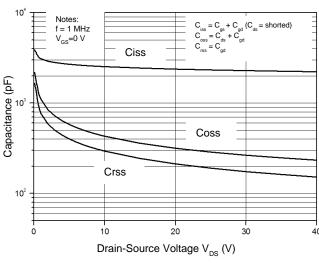


Figure 4. Gate Charge Waveform

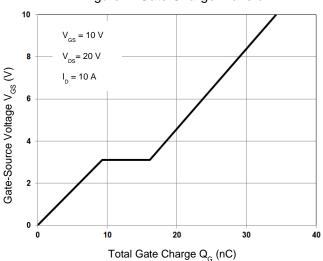


Figure 5. Body-Diode Characteristics

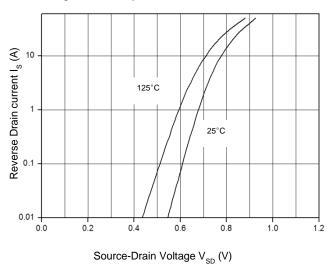


Figure 6. Rdson-Drain Current

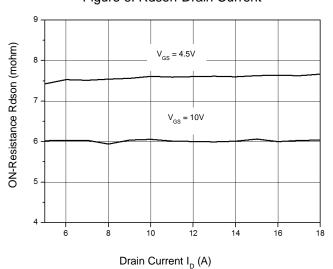




Figure 7. Rdson-Junction Temperature (°C)

1.8

Output

1.0

0.8

0.8

0.8

T-Junction Temperation (°C)

Figure 8. Maximum Safe Operating Area

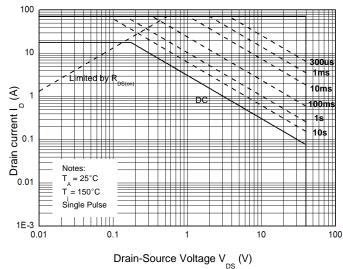
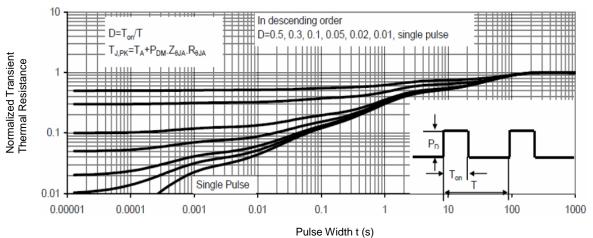


Figure 9. Normalized Maximum Transient Thermal Impedance (RthJA)

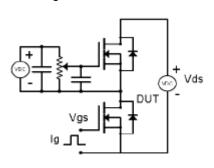


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Test Circuit & Waveform

Figure 8. Gate Charge Test Circuit & Waveform



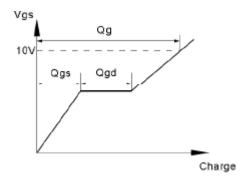
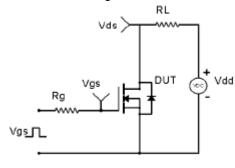


Figure 9. Resistive Switching Test Circuit & Waveforms



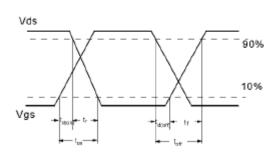
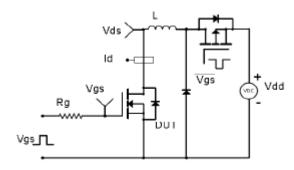


Figure 10. Unclamped Inductive Switching (UIS) Test Circuit & Waveform



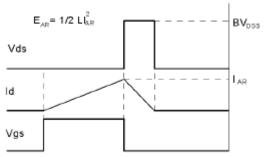
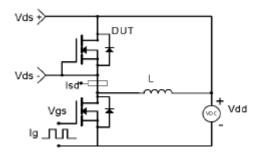
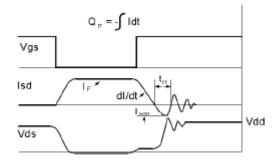


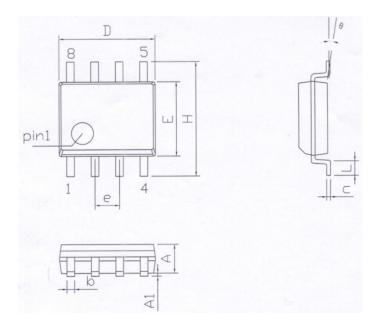
Figure 11. Diode Recovery Circuit & Waveform





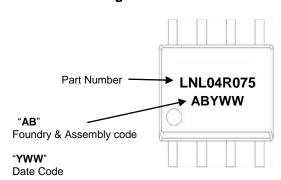


Mechanical Dimensions for SOP-8



COMMON DIMENSIONS					
SYMBOL	MILLIMETERS		INCHS		
	MIN	MAX	MIN	MAX	
Α	1.35	1.65	0.053	0.065	
A1	0.10	0.25	0.004	0.010	
b	0.35	0.50	0.014	0.020	
С	0.19	0.27	0.007	0.011	
D	4.80	5.10	0.189	0.201	
Е	3.80	4.10	0.150	0.161	
е	1.22	1.32	0.048	0.052	
Н	5.80	6.20	0.228	0.244	
L	0.60	0.90	0.024	0.035	
θ	0°	8°	0°	8°	

SOP-8 Part Marking Information





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